



S/N 10/789,736

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Zhiping Yin et al. Examiner: Bradley K. Smith
Serial No.: 10/789,736 Group Art Unit: 2891
Filed: February 27, 2004 Docket: 303.885US1
Title: TRANSPARENT AMORPHOUS CARBON STRUCTURE IN
SEMICONDUCTOR DEVICES

COMMUNICATION CONCERNING RELATED APPLICATION(S)

MS RCE

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Applicants would like to bring to the Examiner's attention the following related application(s) in the above-identified patent application:

<u>Serial/Patent No.</u>	<u>Filing Date/Issue Date</u>	<u>Attorney Docket</u>	<u>Title</u>
10661379	September 12, 2003	303.864US1	TRANSPARENT AMORPHOUS CARBON STRUCTURE IN SEMICONDUCTOR DEVICES
10661100 7129180	September 12, 2003	303.869US1	MASKING STRUCTURE HAVING MULTIPLE LAYERS INCLUDING AN AMORPHOUS CARBON LAYER
11215614	August 30, 2005	303.864US2	TRANSPARENT AMORPHOUS CARBON STRUCTURE IN SEMICONDUCTOR DEVICES
11215532	August 30, 2005	303.864US3	TRANSPARENT AMORPHOUS CARBON STRUCTURE IN SEMICONDUCTOR DEVICES
11215761	August 30, 2005	303.864US4	TRANSPARENT AMORPHOUS CARBON STRUCTURE IN SEMICONDUCTOR DEVICES
11215671	August 30, 2005	303.869US2	MASKING STRUCTURE HAVING MULTIPLE LAYERS INCLUDING AN AMORPHOUS CARBON LAYER
11458642	July 19, 2006	303.885US2	TRANSPARENT AMORPHOUS CARBON STRUCTURE IN SEMICONDUCTOR DEVICES

Continuations and divisionals may be later filed on the cases listed above, or cited to the Examiner in any previous Communication Concerning Related Applications. Applicants request

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that the Examiner review all continuations and divisionals of the above-listed or previously-cited patent applications before allowing the claims of the present patent application.

Respectfully submitted,

ZHIPING YIN ET AL.

By Applicants' Representatives,

SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A.

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(612) 371-2157

Date 18 October 2006 By

David R. Cochran

Reg. No. 46,632

CERTIFICATE UNDER 37 CFR 1.8: The undersigned hereby certifies that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail, in an envelope addressed to: MS RCE, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on this 18 day of October, 2006.

Kate Cannon
Name

Kate Cannon
Signature

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PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:	Zhiping Yin et al.	Examiner:	Bradley K Smith
Serial No.:	10/789,736	Group Art Unit:	2891
Filed:	February 27, 2004	Docket:	303.885US1
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SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

MS RCE
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

In compliance with the duty imposed by 37 C.F.R. § 1.56, and in accordance with 37 C.F.R. §§ 1.97 *et. seq.*, the enclosed materials are brought to the attention of the Examiner for consideration in connection with the above-identified patent application. Applicants respectfully request that this Supplemental Information Disclosure Statement be made of record.

Applicant wishes to bring to the Examiner's attention the PCT Written Opinion of the Searching Authority for the PCT Application No. PCT/US2004/029172 and the European Examination Report for European Patent Application No. 04783428.8, which are foreign counterparts of U.S. Application Serial No. 10/661,379 from which the instant application, as a continuation-in-part application, claims priority. Applicant has enclosed a copy of the PCT Written Opinion of the Searching Authority and a copy of the European Examination Report.

Pursuant to 37 C.F.R. §1.97(b), it is believed that no fee or statement is required with the Supplemental Information Disclosure Statement. However, the Commissioner is hereby authorized to charge the required fees to Deposit Account No. 19-0743 in order to have this Supplemental Information Disclosure Statement considered.

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The Examiner is invited to contact the Applicants' Representative at the below-listed telephone number if there are any questions regarding this communication.

Respectfully submitted,

ZHIPING YIN ET AL.

By their Representatives,

SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A.
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KATE GANNON
Name

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